EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	7102	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L2	23	(gallivan and brown).in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L3	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L4	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L5	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L6	7131	L1 or L2 or L3 or L4 or L5	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L7	9	L6 and (levitate or float) with heat and (mm or milimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L8	9	L6 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L9	0	L8 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L10	113	L6 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L11	103	L6 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L12	12577	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L13	12604	L6 or L12	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L14	8	L13 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16

L15	11	L13 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L16	3	L13 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L17	0	L14 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L18	951355	L13 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L19	16	L13 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L20	7102	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L21	23	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L22	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L23	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L24	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L25	7131	L20 or L21 or L22 or L23 or L24	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L26	12577	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L27	12604	L25 or L26	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L28	11	L27 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L29	11	L28 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L30	7102	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16

L31	23	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L32	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L33	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L34	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L35	7131	L20 or L21 or L22 or L23 or L24	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L36	9	L25 and (levitate or float) with heat and (mm or milimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L37	9	L25 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L38	0	L37 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L39	113	L25 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L40	103	L25 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L41	12577	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L42	12604	L25 or L26	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L43	8	L27 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L44	11	L27 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L45	3	L27 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16

L46	0	L43 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L47	951355	L27 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L48	16	L27 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L49	7102	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L50	23	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L51	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L52	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L53	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L54	7131	L49 or L50 or L51 or L52 or L53	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L55	9	L54 and (levitate or float) with heat and (mm or milimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L56	9	L54 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L57	0	L56 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L58	113	L54 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L59	103	L54 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L60	12577	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16

L61	12604	L54 or L60	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L62	8	L61 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L63	11	L61 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L64	3	L61 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L65	0	L62 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L66	951355	L61 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L67	16	L61 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L68	7102	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L69	23	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L70	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L71	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L72	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L73	7131	L68 or L69 or L70 or L71 or L72	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L74	12577	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L75	12604	L73 or L74	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L76	11	L75 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16

L77	11	L76 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L78	7102	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L79	23	(gallivan and brown).in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L80	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L81	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L82	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L83	7131	L68 or L69 or L70 or L71 or L72	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L84	9	L73 and (levitate or float) with heat and (mm or milimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L85	9	L73 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L86	0	L85 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L87	113	L73 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L88	103	L73 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L89	12577	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L90	12604	L73 or L74	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L91	11	L75 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16

L92	3	L75 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L93	8	L75 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L94	0	L93 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L95	951355	L75 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L96	9	L73 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L97	8	L75 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L98	16	L75 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L99	7102	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L100	23	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L101	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L102	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L103	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L104	7131	L49 or L50 or L51 or L52 or L53	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L105	9	L54 and (levitate or float) with heat and (mm or milimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L106	9	L54 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16

L107	0	L56 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L108	113	L54 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L109	103	L54 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L110	12577	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L111	12604	L54 or L60	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L112	8	L61 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L113	11	L61 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L114	3	L61 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L115	0	L62 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L116	951355	L61 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L117	16	L61 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L118	7102	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L119	23	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L120	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L121	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L122	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16

L123	7131	L68 or L69 or L70 or L71 or L72	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L124	12577	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L125	12604	L73 or L74	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L126	11	L75 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L127	11	L76 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L128	7102	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L129	23	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L130	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L131	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L132	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L133	7131	L68 or L69 or L70 or L71 or L72	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L134	9	L73 and (levitate or float) with heat and (mm or milimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L135	0	L85 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L136	113	L73 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L137	103	L73 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L138	12577	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16

L139	12604	L73 or L74	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L140	11	L75 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L141	3	L75 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L142	0	L93 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L143	951355	L75 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L144	9	L73 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L145	8	L75 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L146	16	L75 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L147	7	L61 and wafer with array with amplifier	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L148	10	millimeter and frequency and wafer with array with amplifier	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L149	4	wafer with "power amplifier" with array with wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L150	4	wafer with "power amplifier" with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L151	77	wafer with " amplifier" with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L152	3	L151 and millimeter with frequency	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L153	0	L151 and 219/748. ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16

L154	0	L151 and "219"/$.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L155	3529	semiconductor with " amplifier" with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L156	0	L155 and 219/748.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L157	1137	semiconductor with " amplifier" with array with plurality	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L158	0	L157 and milimeter with frequency	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L159	209	L157 and frequency	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L160	308	219/748.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L161	0	L160 and active with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L162	73	"219"/$.ccls. and active with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L163	7	"219"/$.ccls. and active with array with semiconductor	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L164	1	"219"/$.ccls. and active with array with antenna	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L165	0	semiconductro and active with array with antenna	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L166	250	semiconductor and active with array with antenna	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L167	1	L166 and donn.in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L168	7102	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L169	23	(gallivan and brown).in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16

L170	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L171	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L172	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L173	7131	L168 or L169 or L170 or L171 or L172	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L174	9	L173 and (levitate or float) with heat and (mm or milimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L175	9	L173 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L176	0	L175 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:16
L177	113	L173 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L178	103	L173 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L179	12577	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L180	12604	L173 or L179	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L181	8	L180 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L182	11	L180 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L183	3	L180 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L184	0	L181 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17

L185	951355	L180 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L186	16	L180 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L187	7102	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L188	23	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L189	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L190	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L191	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L192	7131	L187 or L188 or L189 or L190 or L191	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L193	12577	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L194	12604	L192 or L193	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L195	11	L194 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L196	11	L195 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L197	7102	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L198	23	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L199	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L200	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17

L201	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L202	7131	L187 or L188 or L189 or L190 or L191	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L203	9	L192 and (levitate or float) with heat and (mm or milimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L204	9	L192 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L205	0	L204 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L206	113	L192 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L207	103	L192 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L208	12577	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L209	12604	L192 or L193	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L210	11	L194 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L211	3	L194 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L212	8	L194 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L213	0	L212 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L214	951355	L194 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L215	9	L192 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17

L216	8	L194 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L217	16	L194 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L218	7102	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L219	23	(gallivan and brown).in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L220	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L221	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L222	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L223	7131	L218 or L219 or L220 or L221 or L222	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L224	9	L223 and (levitate or float) with heat and (mm or milimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L225	9	L223 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L226	0	L225 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L227	113	L223 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L228	103	L223 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L229	12577	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L230	12604	L223 or L229	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17

L231	11	L230 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L232	3	L230 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L233	8	L230 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L234	0	L233 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L235	951355	L230 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L236	7102	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L237	23	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L238	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L239	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L240	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L241	7131	L236 or L237 or L238 or L239 or L240	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L242	12577	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L243	12604	L241 or L242	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L244	11	L243 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L245	7102	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L246	23	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17

L247	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L248	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L249	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L250	7131	L236 or L237 or L238 or L239 or L240	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L251	9	L241 and (levitate or float) with heat and (mm or milimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L252	9	L241 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L253	0	L252 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L254	113	L241 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L255	103	L241 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L256	12577	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L257	12604	L241 or L242	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L258	11	L243 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L259	8	L243 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L260	0	L259 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L261	951355	L243 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17

L262	9	L223 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L263	8	L230 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L264	16	L230 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L265	11	L244 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L266	9	L241 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L267	8	L243 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L268	16	L243 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L269	7102	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L270	23	(gallivan and brown).in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L271	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L272	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L273	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L274	7131	L218 or L219 or L220 or L221 or L222	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L275	9	L223 and (levitate or float) with heat and (mm or milimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L276	0	L225 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17

L277	113	L223 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L278	103	L223 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L279	12577	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L280	12604	L223 or L229	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L281	11	L230 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L282	3	L230 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L283	0	L233 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L284	951355	L230 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L285	7102	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L286	23	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L287	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L288	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L289	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L290	7131	L236 or L237 or L238 or L239 or L240	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L291	12577	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L292	12604	L241 or L242	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17

L293	11	L243 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L294	7102	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L295	23	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L296	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L297	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L298	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L299	7131	L236 or L237 or L238 or L239 or L240	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L300	9	L241 and (levitate or float) with heat and (mm or milimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L301	0	L252 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L302	113	L241 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L303	103	L241 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L304	12577	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L305	12604	L241 or L242	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L306	11	L243 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L307	3	L243 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L308	0	L259 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17

L309	951355	L243 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L310	9	L223 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L311	8	L230 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L312	3	L243 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L313	16	L230 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L314	11	L244 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L315	9	L241 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L316	8	L243 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L317	16	L243 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L318	7	L230 and wafer with array with amplifier	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L319	10	millimeter and frequency and wafer with array with amplifier	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L320	4	wafer with "power amplifier" with array with wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L321	4	wafer with "power amplifier" with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L322	77	wafer with " amplifier" with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L323	3	L322 and millimeter with frequency	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17

L324	77	wafer with " amplifier" with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L325	0	L322 and 219/748. ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L326	0	L322 and "219"/$. ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L327	3529	semiconductor with " amplifier" with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L328	0	L327 and 219/748. ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L329	1137	semiconductor with " amplifier" with array with plurality	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L330	0	L329 and milimeter with frequency	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L331	209	L329 and frequency	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L332	308	219/748.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L333	0	L332 and active with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L334	73	"219"/$.ccls. and active with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L335	7	"219"/$.ccls. and active with array with semiconductor	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L336	1	"219"/$.ccls. and active with array with antenna	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L337	0	semiconductro and active with array with antenna	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L338	250	semiconductor and active with array with antenna	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L339	1	L338 and donn.in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17

L340	9472	219/678-748.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L341	9475	L340 or L170 or L171	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L342	7102	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L343	23	(gallivan and brown).in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L344	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L345	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L346	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L347	7131	L342 or L343 or L344 or L345 or L346	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L348	9	L347 and (levitate or float) with heat and (mm or milimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L349	9	L347 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L350	0	L349 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L351	113	L347 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L352	103	L347 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L353	12577	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L354	12604	L347 or L353	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17

L355	8	L354 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L356	11	L354 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L357	3	L354 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L358	0	L355 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L359	951355	L354 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L360	16	L354 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L361	7102	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L362	23	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L363	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L364	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L365	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L366	7131	L361 or L362 or L363 or L364 or L365	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L367	12577	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L368	12604	L366 or L367	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L369	11	L368 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L370	11	L369 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17

L371	7102	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L372	23	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L373	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L374	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L375	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L376	7131	L361 or L362 or L363 or L364 or L365	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L377	9	L366 and (levitate or float) with heat and (mm or milimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L378	9	L366 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L379	0	L378 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L380	113	L366 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L381	103	L366 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L382	12577	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L383	12604	L366 or L367	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L384	8	L368 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L385	11	L368 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17

L386	3	L368 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L387	0	L384 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L388	951355	L368 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L389	16	L368 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L390	7102	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L391	23	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L392	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L393	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L394	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L395	7131	L390 or L391 or L392 or L393 or L394	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L396	9	L395 and (levitate or float) with heat and (mm or milimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L397	9	L395 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L398	0	L397 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L399	113	L395 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L400	103	L395 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17

L401	12577	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L402	12604	L395 or L401	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L403	8	L402 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L404	11	L402 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L405	3	L402 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L406	0	L403 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L407	951355	L402 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L408	16	L402 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L409	7102	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L410	23	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L411	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L412	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L413	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L414	7131	L409 or L410 or L411 or L412 or L413	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L415	12577	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L416	12604	L414 or L415	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17

L417	11	L416 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L418	11	L417 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L419	7102	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L420	23	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L421	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L422	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L423	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L424	7131	L409 or L410 or L411 or L412 or L413	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L425	9	L414 and (levitate or float) with heat and (mm or milimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L426	9	L414 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L427	0	L426 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L428	113	L414 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L429	103	L414 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L430	12577	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L431	12604	L414 or L415	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17

L432	11	L416 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L433	3	L416 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L434	8	L416 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L435	0	L434 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L436	951355	L416 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L437	9	L414 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L438	8	L416 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L439	16	L416 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L440	7102	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L441	23	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L442	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L443	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L444	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L445	7131	L390 or L391 or L392 or L393 or L394	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L446	9	L395 and (levitate or float) with heat and (mm or milimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17

L447	9	L395 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L448	0	L397 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L449	113	L395 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L450	103	L395 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L451	12577	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L452	12604	L395 or L401	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L453	8	L402 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L454	11	L402 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L455	3	L402 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L456	0	L403 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L457	951355	L402 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L458	16	L402 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L459	7102	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L460	23	(gallivan and brown).in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L461	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L462	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17

L463	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L464	7131	L409 or L410 or L411 or L412 or L413	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L465	12577	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L466	12604	L414 or L415	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L467	11	L416 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L468	11	L417 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L469	7102	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L470	23	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L471	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L472	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L473	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L474	7131	L409 or L410 or L411 or L412 or L413	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L475	9	L414 and (levitate or float) with heat and (mm or milimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L476	0	L426 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L477	113	L414 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L478	103	L414 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17

L479	12577	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L480	12604	L414 or L415	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L481	11	L416 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L482	3	L416 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L483	0	L434 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L484	951355	L416 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L485	9	L414 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L486	8	L416 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L487	16	L416 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L488	7	L402 and wafer with array with amplifier	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L489	10	millimeter and frequency and wafer with array with amplifier	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L490	4	wafer with "power amplifier" with array with wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L491	4	wafer with "power amplifier" with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L492	77	wafer with " amplifier" with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:17
L493	3	L492 and millimeter with frequency	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18

L494	0	L492 and 219/748. ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L495	0	L492 and "219"/$. ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L496	3529	semiconductor with " amplifier" with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L497	0	L496 and 219/748. ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L498	1137	semiconductor with " amplifier" with array with plurality	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L499	0	L498 and milimeter with frequency	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L500	209	L498 and frequency	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L501	308	219/748.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L502	0	L501 and active with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L503	73	"219"/$.ccls. and active with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L504	7	"219"/$.ccls. and active with array with semiconductor	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L505	1	"219"/$.ccls. and active with array with antenna	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L506	0	semiconductro and active with array with antenna	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L507	250	semiconductor and active with array with antenna	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L508	1	L507 and donn.in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L509	7102	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18

L510	23	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L511	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L512	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L513	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L514	7131	L509 or L510 or L511 or L512 or L513	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L515	9	L514 and (levitate or float) with heat and (mm or milimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L516	9	L514 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L517	0	L516 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L518	113	L514 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L519	103	L514 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L520	12577	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L521	12604	L514 or L520	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L522	8	L521 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L523	11	L521 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L524	3	L521 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18

L525	0	L522 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L526	951355	L521 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L527	16	L521 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L528	7102	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L529	23	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L530	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L531	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L532	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L533	7131	L528 or L529 or L530 or L531 or L532	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L534	12577	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L535	12604	L533 or L534	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L536	11	L535 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L537	11	L536 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L538	7102	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L539	23	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L540	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18

L541	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L542	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L543	7131	L528 or L529 or L530 or L531 or L532	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L544	9	L533 and (levitate or float) with heat and (mm or milimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L545	9	L533 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L546	0	L545 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L547	113	L533 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L548	103	L533 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L549	12577	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L550	12604	L533 or L534	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L551	11	L535 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L552	3	L535 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L553	8	L535 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L554	0	L553 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L555	951355	L535 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18

L556	9	L533 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L557	8	L535 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L558	16	L535 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L559	7102	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L560	23	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L561	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L562	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L563	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L564	7131	L559 or L560 or L561 or L562 or L563	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L565	9	L564 and (levitate or float) with heat and (mm or milimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L566	9	L564 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L567	0	L566 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L568	113	L564 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L569	103	L564 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L570	12577	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18

L571	12604	L564 or L570	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L572	11	L571 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L573	3	L571 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L574	8	L571 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L575	0	L574 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L576	951355	L571 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L577	7102	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L578	23	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L579	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L580	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L581	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L582	7131	L577 or L578 or L579 or L580 or L581	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L583	12577	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L584	12604	L582 or L583	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L585	11	L584 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L586	7102	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18

L587	23	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L588	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L589	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L590	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L591	7131	L577 or L578 or L579 or L580 or L581	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L592	9	L582 and (levitate or float) with heat and (mm or milimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L593	9	L582 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L594	0	L593 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L595	113	L582 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L596	103	L582 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L597	12577	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L598	12604	L582 or L583	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L599	11	L584 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L600	8	L584 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L601	0	L600 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18

L602	951355	L584 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L603	9	L564 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L604	8	L571 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L605	16	L571 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L606	11	L585 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L607	9	L582 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L608	8	L584 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L609	16	L584 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L610	7102	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L611	23	(gallivan and brown).in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L612	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L613	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L614	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L615	7131	L559 or L560 or L561 or L562 or L563	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L616	9	L564 and (levitate or float) with heat and (mm or milimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18

L617	0	L566 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L618	113	L564 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L619	103	L564 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L620	12577	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L621	12604	L564 or L570	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L622	11	L571 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L623	3	L571 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L624	0	L574 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L625	951355	L571 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L626	7102	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L627	23	(gallivan and brown).in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L628	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L629	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L630	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L631	7131	L577 or L578 or L579 or L580 or L581	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L632	12577	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18

L633	12604	L582 or L583	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L634	11	L584 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L635	7102	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L636	23	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L637	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L638	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L639	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L640	7131	L577 or L578 or L579 or L580 or L581	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L641	9	L582 and (levitate or float) with heat and (mm or milimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L642	0	L593 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L643	113	L582 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L644	103	L582 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L645	12577	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L646	12604	L582 or L583	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L647	11	L584 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L648	3	L584 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18

L649	0	L600 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L650	951355	L584 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L651	9	L564 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L652	8	L571 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L653	3	L584 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L654	16	L571 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L655	11	L585 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L656	9	L582 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L657	8	L584 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L658	16	L584 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L659	7	L571 and wafer with array with amplifier	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L660	10	millimeter and frequency and wafer with array with amplifier	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L661	4	wafer with "power amplifier" with array with wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L662	4	wafer with "power amplifier" with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L663	77	wafer with " amplifier" with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18

L664	3	L663 and millimeter with frequency	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L665	77	wafer with " amplifier" with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L666	0	L663 and 219/748. ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L667	0	L663 and "219"/$. ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L668	3529	semiconductor with " amplifier" with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L669	0	L668 and 219/748. ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L670	1137	semiconductor with " amplifier" with array with plurality	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L671	0	L670 and milimeter with frequency	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L672	209	L670 and frequency	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L673	308	219/748.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L674	0	L673 and active with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L675	73	"219"/$.ccls. and active with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L676	7	"219"/$.ccls. and active with array with semiconductor	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L677	1	"219"/$.ccls. and active with array with antenna	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L678	0	semiconductro and active with array with antenna	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L679	250	semiconductor and active with array with antenna	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18

L680	1	L679 and donn.in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L681	9472	219/678-748.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L682	9475	L681 or L511 or L512	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L683	6	"6572830".pn. or "5886671".pn. or "6765535".pn.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:18
L684	279	219/748.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:19
L685	428	219/748-749.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/10/20 08:19

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